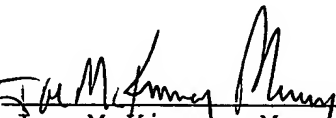


- ☒ No fee is required.
- ☐ A check in the amount of \$0.00 is enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By 
Joe McKinney Muncy, #32,334

KM/asc
3313-1099P

P.O. Box 747
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Attachment(s)



MS ISSUE FEE
PATENT
3313-1099P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: CHANG, Shu-Ming et al. Conf.: 2341
Appl. No.: 10/765,961 Group: 2815
Filed: January 29, 2004 Examiner: Sheila V. Clark
For: WAFER LEVEL CHIP SCALE PACKAGING STRUCTURE
AND METHOD OF FABRICATING THE SAME

AMENDMENT UNDER 37 C.F.R. § 1.312

HANDCARRY TO:
U.S. Patent and Trademark Office
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Randolph Building
401 Dulany Street
Alexandria, VA 22314

March 11, 2005

Sir:

Pursuant to the provisions of 37 C.F.R. § 1.312, the following amendments and remarks are respectfully submitted in connection with the above-identified application. It is respectfully requested that the following amendments be entered without withdrawing the application from issue.

This amendment includes:

Amended Claim Set; and

Remarks.